

LUVATA View on the Dream Nb_3Sn Conductor for FCC

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FCC Week, Washington, DC
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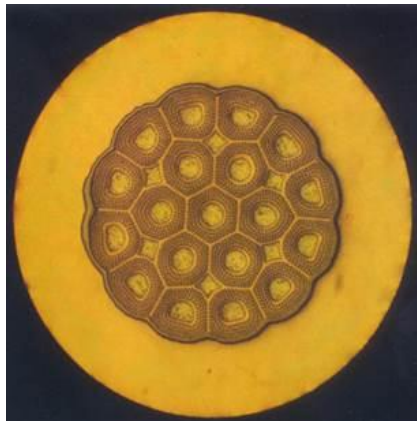


Key Projects with Luvata Participation:

- NbTi for Fermi Lab (>90%), CERN-LHC (30%), GSI-SIS100
- Nb₃Sn for Fusion Programs
 - ITER Central Solenoid Model Coil (CSMC): 1991~1995
 - KSTAR Advanced Performance Strand (HP-3): 1997~2006
 - US & EFDA ITER-TF Prototype Strands: 2004~2007
 - US ITER-TF: 2009~2012
- High Jc Nb₃Sn Conductor Development for HEP
 - US CDP: 2001~2003
 - Next European Dipole (NED): 2007~2010
 - CERN Nb₃SN R&D for LHC Upgrades: 2014~Present

Mass Production Started 1996 with KSTAR:

- First fusion machine utilizing all Nb₃Sn for TF coils in mass production strand quantity.
 - 50% of Nb₃Sn: Produced 12 t of HP-3 type Cr-plated wire
 - 100% of NbTi: Produced 12 t for PF
 - Increased Nb₃Sn billet size to 60 kg, unit length > 13 km
 - Manufacturing equipment upgrade enabling mass production
 - Production rate achieved 1.8 t per month



- Enhanced Performance
 - Non-Cu J_c : 850-900 A/mm² (4.2 K, 12 T)
 - Non-Cu Q_h : 220-270 kJ/m³ (± 3 T cycle)

Equipment Upgrade for Larger Billet Unit

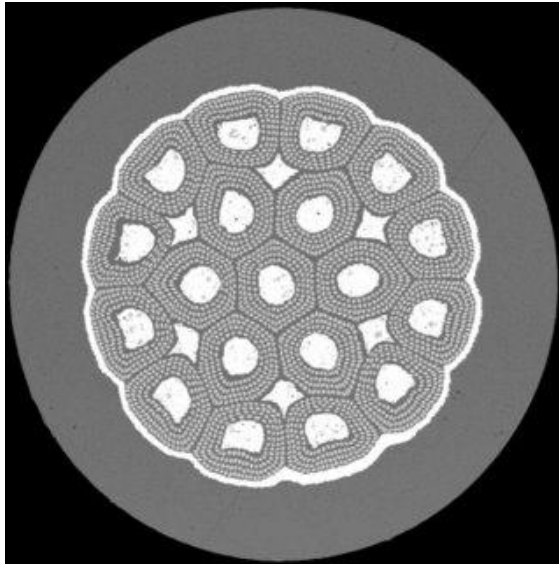
2.2 m - BB



1.5 m - BB



Nb₃Sn Production for US ITER-TF



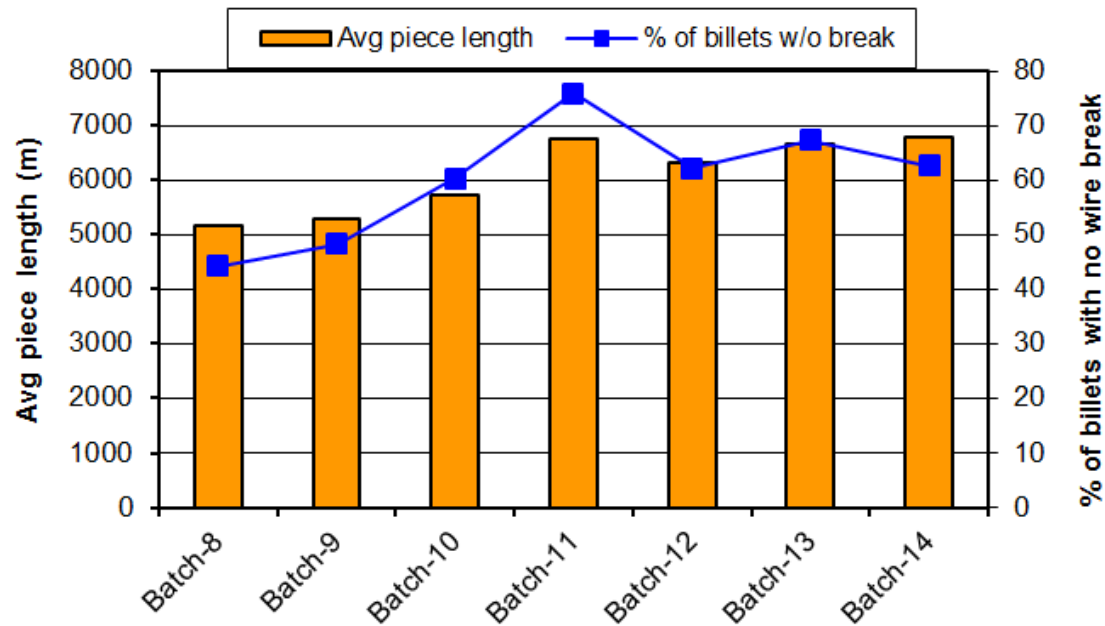
Cr-plated TF SC Strand:

- 32 t of Cr-plated Nb₃Sn (6430 km)
- 2.3 t / mo. x 14 monthly batches

Cr-plated TF Cu Strand:

- 23 t of Cr-plated Cu (4795 km)
- 1.6 t / mo. x 14 monthly batches

Piece Length Performance - ITER TF Strand

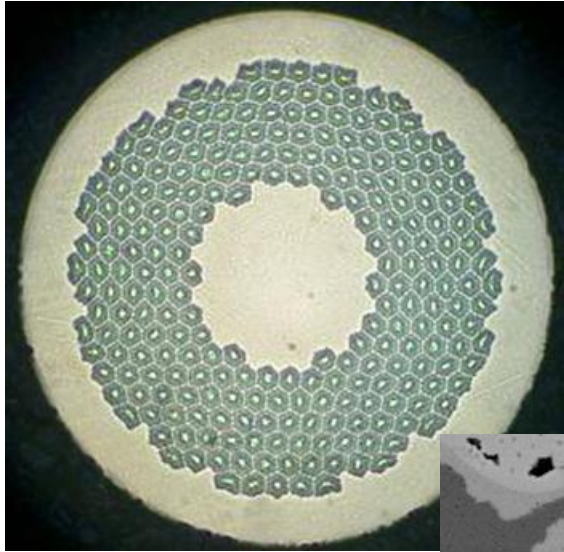


- Average piece length:
 - Over **6600 m** (*mature process*)
- Billets with no wire breaks:
 - **2/3 of billets in single length**

High J_c Nb₃Sn for HEP:

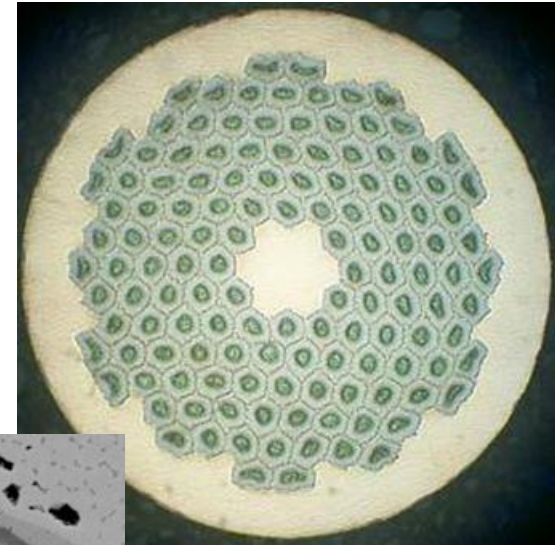
- Nb Rod-in-Cu Tube (RIT) Process
 - Ti addition through Sn core
- R&D for CERN
 - Wire for HL-LHC upgrades
 - Wire design for: J_c , D_{eff} , RRR & **drawability**
 - Restacking architecture
 - SnTi microstructure refinement

RIT-3: *NED*



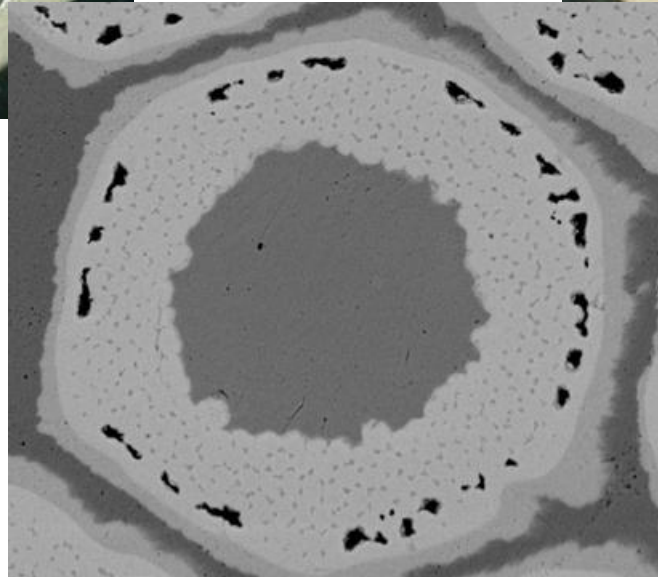
Design: B1

- 1.25 mm
- **258/313** pattern
- Cu: 55%
- Subelement: 45 μm



Design: B2

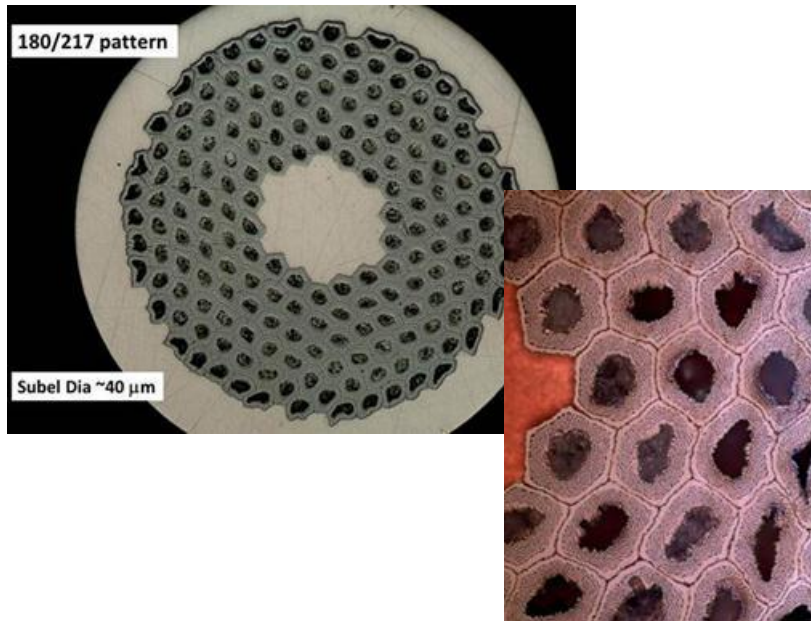
- 1.25 mm
- **132/139** pattern
- Cu: 54%
- Subelement: 78 μm



RIT-4: CERN R&D – 1st set

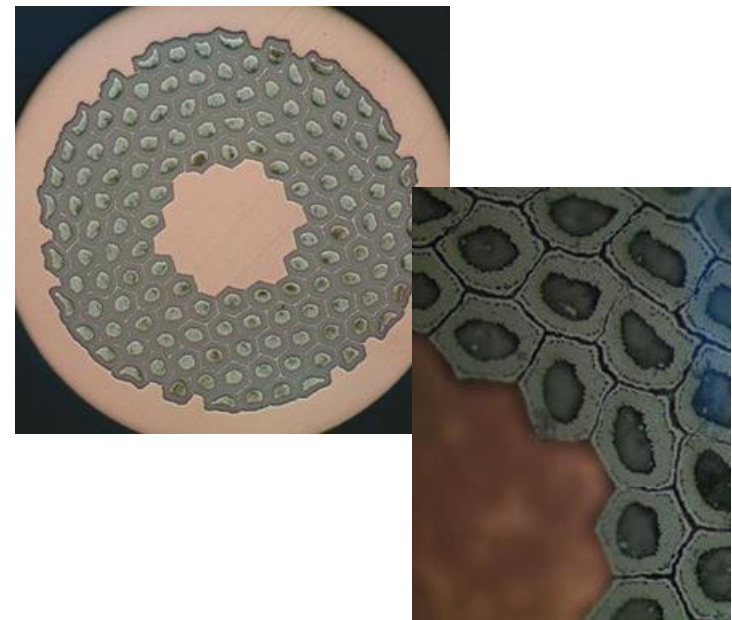
Rod-In-Tube (RIT) – Increased filament count, thicker Nb barrier and SnTi core with improved microstructure.

180/217 Stack



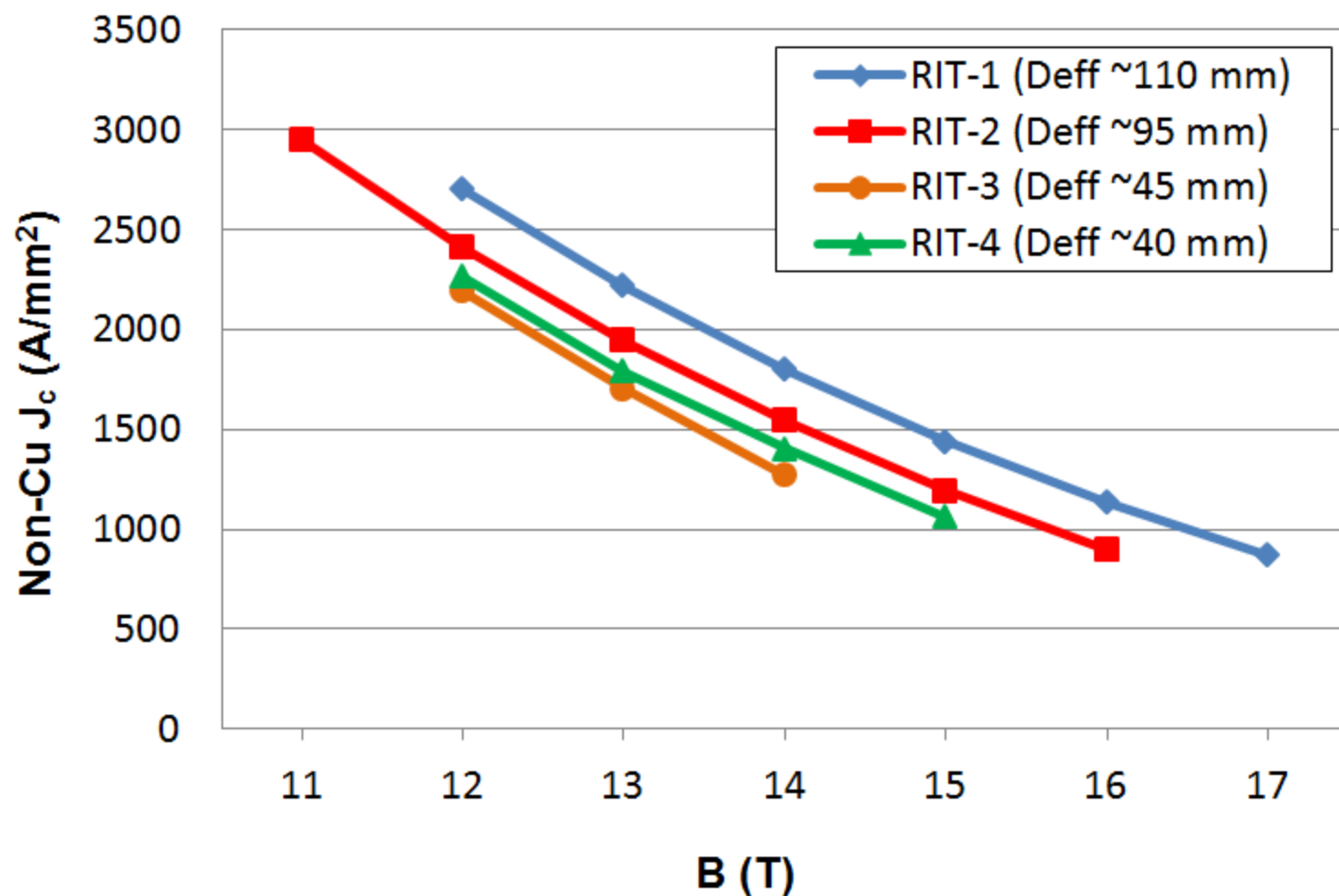
80% of wire > 400 m
Subelement dia ~40 μm

132/169 Stack



82% of wire > 400 m
Subelement dia ~45 μm

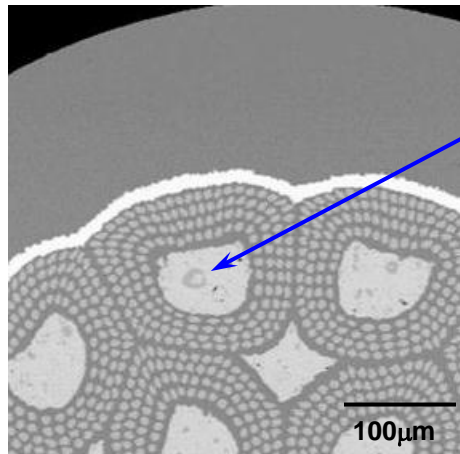
Non-Cu J_c vs. B :



Effect of Ti_6Sn_5 Precipitate Size:

SnTi core approach required further refinement of microstructure and uniformity of precipitate for reduced subelement size.

$D_{\text{subel}} > 110 \text{ mm}$

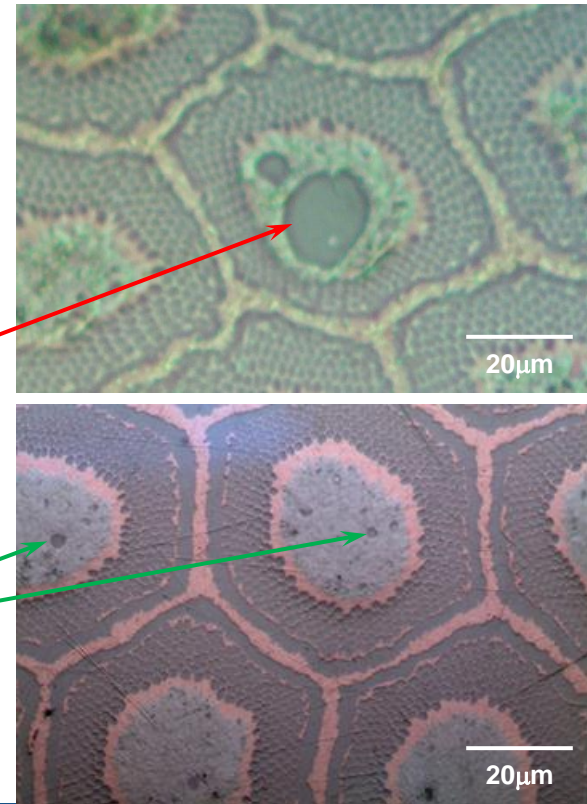


Particles much smaller than tin core size

Larger particles becomes problematic!!

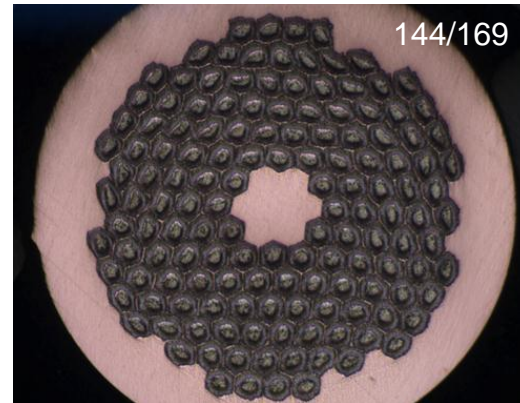
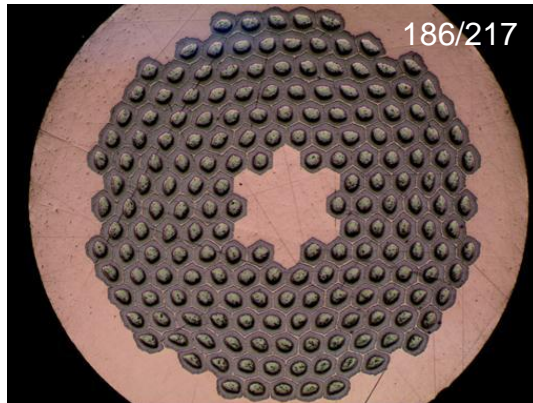
Refined microstructure

$D_{\text{subel}} < 50 \text{ mm}$



RIT-4 (modified): *CERN R&D (2nd Set)*

- Some issues on the first set of restacks:
 - Some subelements distortion is considered a primary factor to low J_c and RRR.
- Modified Restacking Architecture:
 - A specially profiled copper tube along with conforming subelement shape to produce more uniform subelement shape and size.

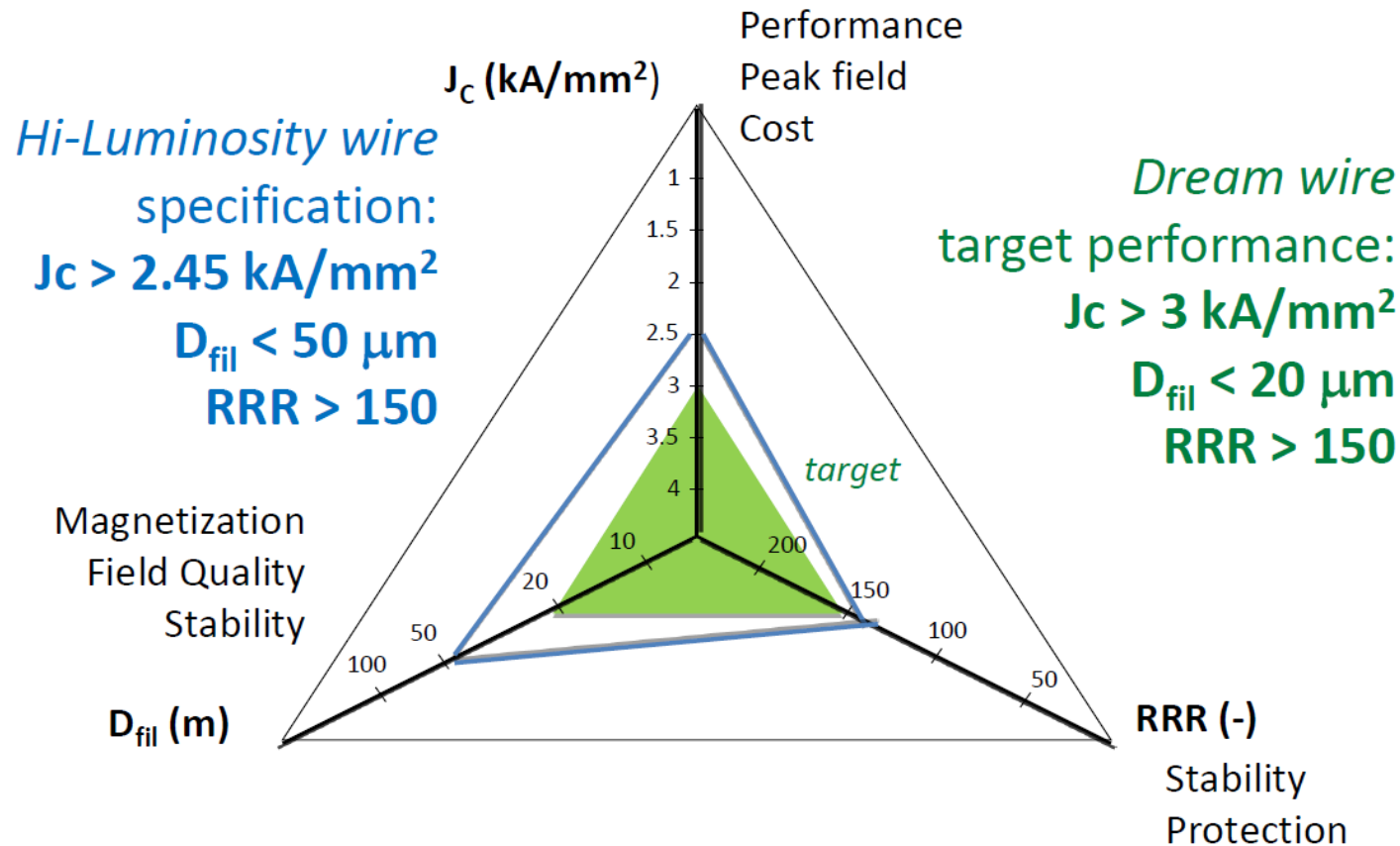


In the process of evaluating the performance.

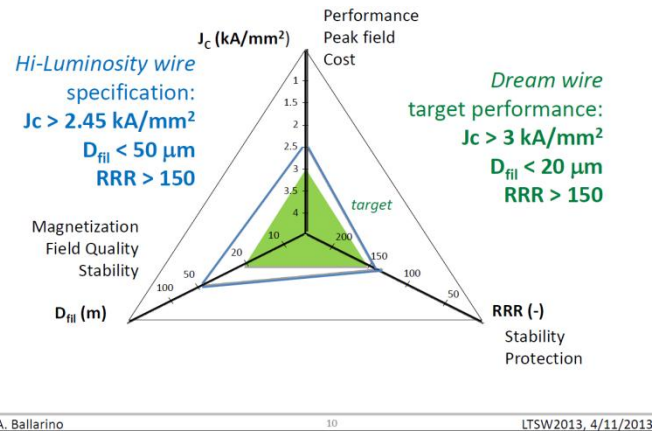
Nb₃Sn Performance Targets:

			Hi-Lumi	FCC
Starnd Diameter	mm		0.7~0.85	0.7~1.0
Non-Cu Jc	A/mm ²	12 T	≥ 2450	≥ 3400
		15 T	≥ 1350	≥ 1850
		16 T	-	≥ 1500
$\mu_0\Delta M$	mT		-	≤ 150
$\sigma(\mu_0\Delta M)$	%		-	≤ 4.5
D _{fil}	μm		≤ 50	≤ 20
RRR	-		≥ 150	≥ 150
Unit Length	km		≥ 0.4	≥ 5
Cost (16 T, 4.2 K)	\$/kA-m		-	≤ 5

Nb₃Sn Specifications:



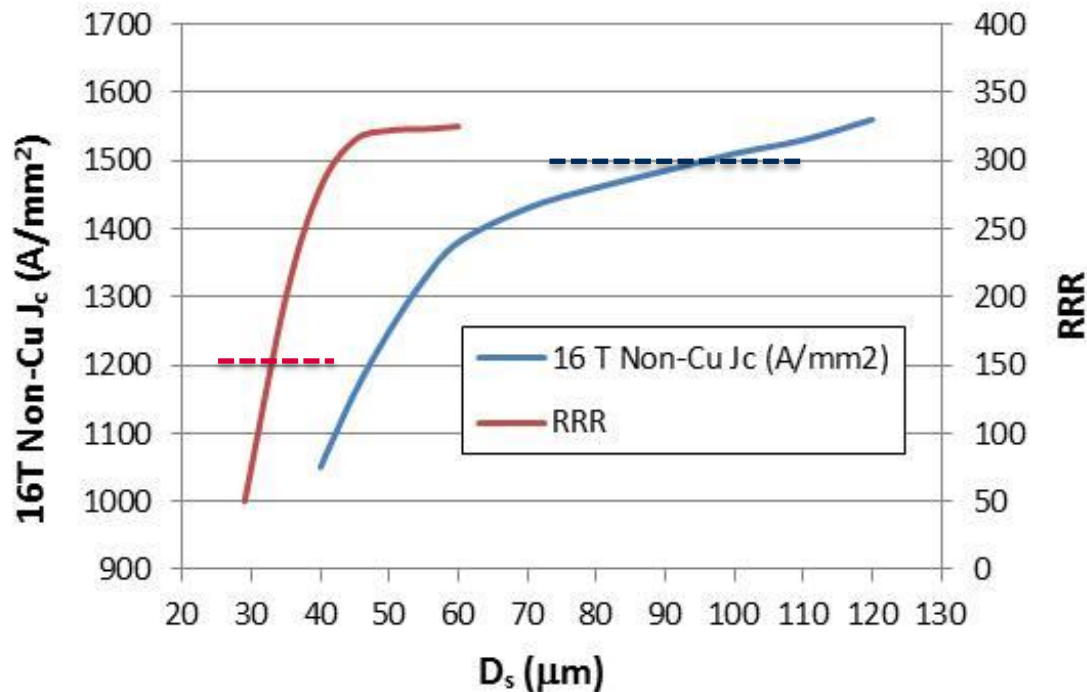
4th & 5th dimensions



- Long piece lengths >5 km
- Reasonable cost <\$5 /kAm at 16T

All these 5 dimensions are inter-related and counter-acting

Subelement Size Effect: *Typical Trend*



Both J_c and RRR dropping rapidly below $40\sim 50\text{ }\mu\text{m}$.

Extrinsic factors are responsible

Basic Demands:

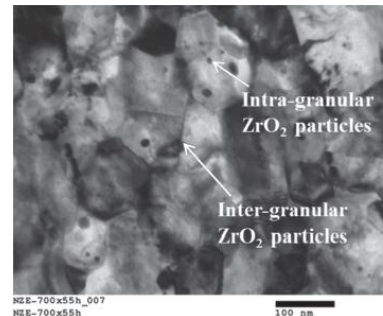
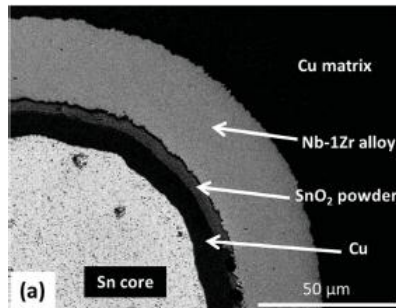
- Jc: Finer grain A15
 - Dopants to Nb (Zr, Hf etc) - Layer Jc
 - Minimize SE distortion
 - Optimized HT
- RRR: Reliable barrier
 - Sufficient barrier thickness
 - Uniform deformation
 - Optimized HT
- Ds / Deff: Composite Ductility
 - Compatible materials
 - Low degradation in cabling
 - “Smart” wire architectures

Basic Demands:

- Long Piece Lengths
 - Large restack assemblies (100 to 150 kg billet size)
 - Freedom from internal defects!
 - “Clean Room” factory environment
- Affordable Cost: Process driven
 - Large restack assemblies (100 to 150 kg billet size)

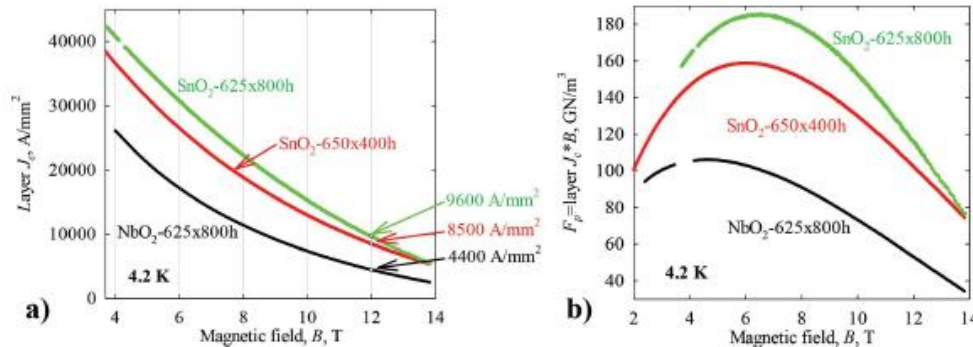
Potential for J_c Enhancement:

- Nb_3Sn grain refinement through internal oxidation.
 - NbZr alloy with oxygen supplied via oxide powder.



Substantial increase
in J_c further is –
***fundamentally
feasible!!***

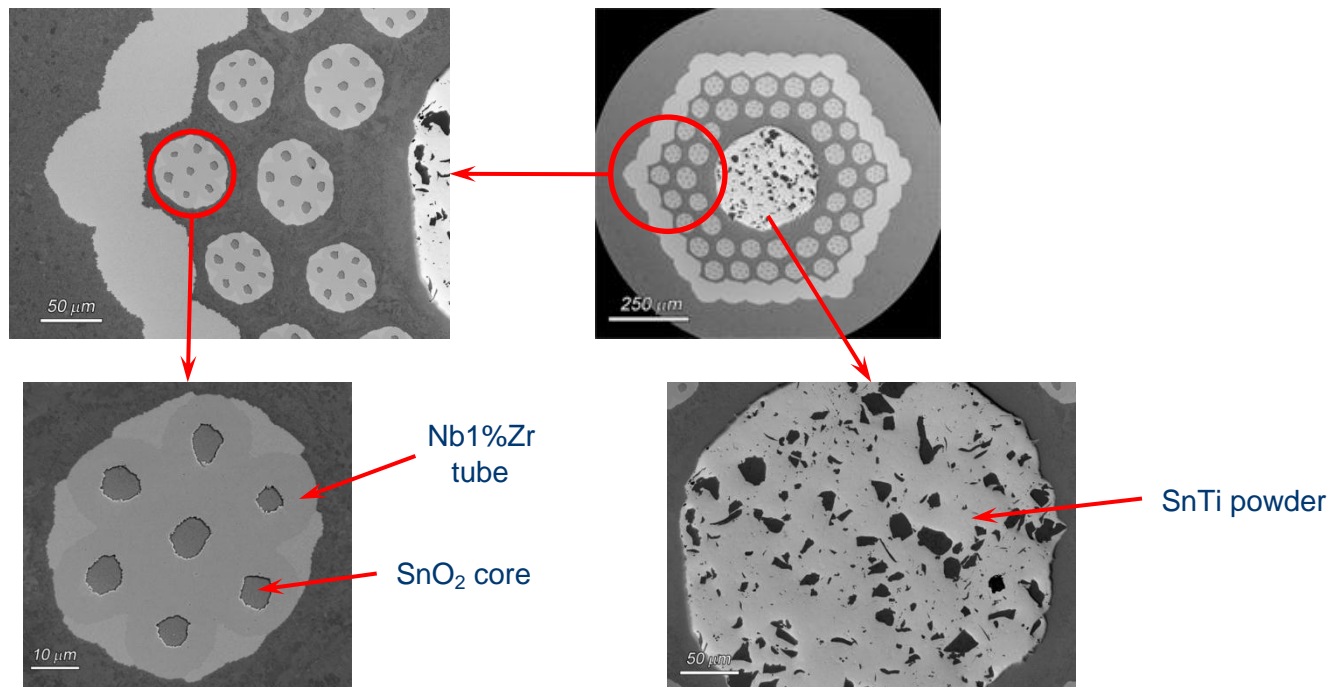
- Layer J_c measured nearly 10,000 A/mm² at 12 T, 4.2 K.



X. Xu and M. Sumption, et al. – Adv. Mater. 2015, 27, 1346-1350

Potential for Finer D_s:

- A wire layout for improved fabricability.
 - Oxygen introduced from SnO₂ core to Nb1%Zr tube.
 - Stacking architecture (hexagon or octagon) to promote uniform co-reduction.



*L. Motowidlo – Supramagnetics
SBIR Phase-2, 2015*

Final Thoughts

- It is unlikely that current distributed barrier Internal-Tin or Tubular approaches will overcome the hurdles
- New and “out-of-the-box” thinking is necessary in the selection of material combination and wire architectures
 - **Control of “Extrinsic Factors” is key**
 - Questions need to be raised early if an approach is scalable
- Scale-up of final stage assembly
 - Difficulties/challenges grossly ignored in the past
 - Several years of production practice to understand “economics”
- Proper effort and adequate funding are essential
 - 10% of estimated SC budget for R&D! Will pay back multi-fold

***Anyone can make a sample with exciting properties;
Can you make 5 km with the same performance in every mm
and in tonnage quantity?***

-Bruce Strauss

Thank you !

LUVATATM

Partnerships beyond metals